

# WILK ELEKTRONIK S.A.

ul. Mikołowska 42, 43-173 Łaziska Górne, Poland Website: <u>www.goodram.com</u> | <u>www.wilk.com.pl</u> Tel: +48 (32) 736 90 00 Fax: +48 (32) 736 90 01

# Wilk Elektronik S.A.

# **GOODRAM Industrial CFast TM**

# Version 1.1

All rights are strictly reserved. Any portion of this paper shall not be reproduced, copied, or translated to any other forms without permission from Wilk Elektronik S.A.

GOODRAM logo is registered trademark of Wilk Elektronik S.A. All other trademarks and logos are the property of their respective owners. All products and specifications are subject to change without notice. Wilk Elektronik S.A. Poland, 43-173 Łaziska Górne, ul. Mikołowska 42 tel.: 0-32/ 736 90 00, fax: 0-32/ 736 90 01 www.wilk.com.pl I www.goodram.com © Wilk Elektronik S.A. 2014

This document is subjected to change without any notice.

Please contact your Wilk Elektronik S.A. sales representative for details as to environmental matters such as the RoHS compatibility of Product. Please use Product in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. Wilk Elektronik S.A. assumes no liability for damages or losses occurring as a result of noncompliance with applicable laws and regulations.

GOODRAM logo is registered trademark of Wilk Elektronik S.A. All other trademarks and logos are the property of their respective owners. All products and specifications are subject to change without notice. Wilk Elektronik S.A. Poland, 43-173 Łaziska Górne, ul. Mikołowska 42 tel.: 0-32/ 736 90 00, fax: 0-32/ 736 90 01 www.wilk.com.pl I www.goodram.com © Wilk Elektronik S.A. 2014

# **Contents**

1.	Overvie	ew5
2.	Introdu	uction 1
	2.1.	General Description 1
	2.2.	Controller Block Diagram1
	2.3.	Product Block Diagram 2
	2.4.	Flash Management 2
3.	Produc	t Specifications
4.	Enviror	nmental Specifications
	4.1.	Environmental Conditions
	4.2.	Shock
	4.3.	Vibration
	4.4.	Drop
	4.5.	Bending
	4.6.	Torque11
	4.7.	Electrostatic Discharge (ESD) 11
	4.8.	EMI Compliance
	4.9.	MTBF
	4.10.	Certification & Compliance
5.	Electric	cal Specifications 12
	5.1.	Supply Voltage
	5.2.	Power Consumption 12

GOODRAM logo is registered trademark of Wilk Elektronik S.A. All other trademarks and logos are the property of their respective owners. All products and specifications are subject to change without notice. Wilk Elektronik S.A. Poland, 43-173 Łaziska Górne, ul. Mikołowska 42 tel.: 0-32/ 736 90 00, fax: 0-32/ 736 90 01 www.wilk.com.pl I www.goodram.com © Wilk Elektronik S.A. 2014

6.	Interfac	ce	13
	6.1.	Pin Assignment and Descriptions	13
7.	Suppor	ted Commands	14
	7.1.	ATA Command List	14
	7.2.	Identify Device Data	16
8.	Physica	l Dimension	21

Wilk Elektronik S.A. Poland, 43-173 Łaziska Górne, ul. Mikołowska 42 tel.: 0-32/ 736 90 00, fax: 0-32/ 736 90 01 www.wilk.com.pl I www.goodram.com © Wilk Elektronik S.A. 2014

# 1. Overview

- Capacity
  - SLC: 1GB to 32GB
  - MLC: 4GB up to 64GB
- SATA Interface
  - SATA Revision 3.0
  - SATA 1.5Gbps, 3Gbps, and 6Gbps interface
- Flash Interface
  - Flash Type: SLC, MLC
  - Ipc or 2pcs of TSOP
- Performance
  - Read: up to 240 MB/s
  - Write: up to 150 MB/s
- Power Consumption<sup>Note1</sup>
  - Active mode: < 1577mW</li>
  - Idle mode: < 300mW</p>
  - DEVSLP mode: < 5mW</p>
- TBW (Terabyte Written) Note2
  - 158TBW for 64GB

# Notes:

- 1. Please see "5.2 Power Consumption" for details.
- 2. Please see "TBW (Terabyte Written)" in Chapter 3" for details.

- MTBF
  - More than 1,000,000 hours
- Advanced Flash Management
  - Static and Dynamic Wear Leveling
  - Bad Block Management
  - TRIM
  - SMART
  - Over-Provision
  - Firmware Update
- Low Power Management
  - DEVSLP Mode
  - DIPM/HIPM Mode
- Temperature Range
  - Sliver grade: 0°C ~ 70°C
  - Diamond grade: -40°C ~ 85°C
- RoHS compliant

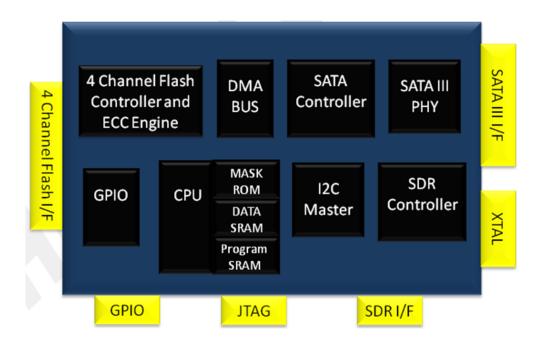
# 2. Introduction

# 2.1. General Description

CFast<sup>™</sup> delivers all the advantages of Flash Disk technology with the Serial ATA III interface and is fully compliant with the standard CFast form factor. Given the features of the low power consumption, small form factor, and high shock-resistance, CFast<sup>™</sup> is an attractive solution to replace the conventional [PATA-interfaced] CompactFlash card in industrial applications or markets where performance is a major concern.

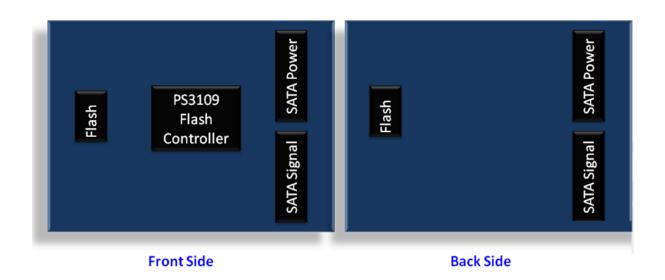
CFast<sup>™</sup>, consisting of a SATA-based 7-pin standard interface for data segment and 17-pin for power and controller segment, is designed to operate at a maximum operating frequency of 300MHz with 40MHz external crystal. Its capacity could provide a wide range up to 64GB. Moreover, it can reach up to 240MB/s read as well as 120MB/s write high performance based on Toggle 2.0 MLC flash (with 32MB SDR enabled and measured by CrystalDiskMark v3.0).

## 2.2. Controller Block Diagram



GOODRAM logo is registered trademark of Wilk Elektronik S.A. All other trademarks and logos are the property of their respective owners. All products and specifications are subject to change without notice. Wilk Elektronik S.A. Poland, 43-173 Łaziska Górne, ul. Mikołowska 42 tel.: 0-32/ 736 90 00, fax: 0-32/ 736 90 01 www.wilk.com.pl I www.goodram.com © Wilk Elektronik S.A. 2014

# 2.3. Product Block Diagram



#### 2.4. Flash Management

• Error Correction Code (ECC)

Flash memory cells will deteriorate with use, which might generate random bit errors in the stored data. Thus, PS3109 CFast applies the BCH ECC Algorithm, which can detect and correct errors occur during Read process, ensure data been read correctly, as well as protect data from corruption.

• Wear Leveling

NAND Flash devices can only undergo a limited number of program/erase cycles, and in most cases, the flash media are not used evenly. If some areas get updated more frequently than others, the lifetime of the device would be reduced significantly. Thus, Wear Leveling technique is applied to extend the lifespan of NAND Flash by evenly distributing write and erase cycles across the media.

It provides advanced Wear Leveling algorithm, which can efficiently spread out the flash usage through the whole flash media area. Moreover, by implementing both dynamic and static Wear Leveling algorithms, the life expectancy of the NAND Flash is greatly improved.

GOODRAM logo is registered trademark of Wilk Elektronik S.A. All other trademarks and logos are the property of their respective owners. All products and specifications are subject to change without notice. Wilk Elektronik S.A. Poland, 43-173 Łaziska Górne, ul. Mikołowska 42 tel.: 0-32/ 736 90 00, fax: 0-32/ 736 90 01 www.wilk.com.pl I www.goodram.com © Wilk Elektronik S.A. 2014

#### Bad Block Management

Bad blocks are blocks that include one or more invalid bits, and their reliability is not guaranteed. Blocks that are identified and marked as bad by the manufacturer are referred to as "Initial Bad Blocks". Bad blocks that are developed during the lifespan of the flash are named "Later Bad Blocks". implements an efficient bad block management algorithm to detect the factory-produced bad blocks and manages any bad blocks that appear with use. This practice further prevents data being stored into bad blocks and improves the data reliability.

#### TRIM

TRIM is a feature which helps improve the read/write performance and speed of Solid-State Drives (SSD). Unlike Hard Disk Drives (HDD), SSDs are not able to overwrite existing data, so the available space gradually becomes smaller with each use. With the TRIM command, the operating system can inform the SSD which blocks of data are no longer in use and can be removed permanently. Thus, the SSD will perform the erase action, which prevents unused data from occupying blocks all the time.

#### SMART

SMART, an acronym for Self-Monitoring, Analysis and Reporting Technology, is an open standard that allows a hard disk drive to automatically detect its health and report potential failures. When a failure is recorded by SMART, users can choose to replace the drive to prevent unexpected outage or data loss. Moreover, SMART can inform users of impending failures while there is still time to perform proactive actions, such as copy data to another device.

#### Over-Provision

Over Provisioning refers to the inclusion of extra NAND capacity in a SSD, which is not visible and cannot be used by users. With Over Provisioning, the performance and IOPS (Input/Output Operations per Second) is improved by providing the controller additional space to manage P/E cycles, which enhances the reliability and endurance as well. Moreover, the write amplification of the SSD becomes lower when the controller writes data to the flash.

#### • Firmware Upgrade

Firmware can be considered as a set of instructions on how the device communicates with the host. Firmware will be upgraded when new features are added, compatibility issues are fixed, or read/write performance gets improved.

Wilk Elektronik S.A. Poland, 43-173 Łaziska Górne, ul. Mikołowska 42 tel.: 0-32/ 736 90 00, fax: 0-32/ 736 90 01 www.wilk.com.pl I www.goodram.com © Wilk Elektronik S.A. 2014

#### • Low Power Management

DEVSLP Mode

With the increasing need of aggressive power/battery life, SATA interfaces include a new feature, Device Sleep (DEVSLP) mode, which helps further reduce the power consumption of the device. DEVSLP enables the device to completely power down the device PHY and other sub-systems, making the device reach a new level of lower power operation. The DEVSLP does not specify the exact power level a device can achieve in the DEVSLP mode, but the power usage can be dropped down to 5mW or less.

#### DIPM/HIPM Mode

SATA interfaces contain two low power management states for power saving: Partial and Slumber modes. For Partial mode, the device has to resume to full operation within 10 microseconds, whereas the device will spend 10 milliseconds to become fully operational in the Slumber mode. SATA interfaces allow low power modes to be initiated by Host (HIPM, Host Initiated Power Management) or Device (DIPM, Device Initiated Power Management). As for HIPM, Partial or Slumber mode can be invoked directly by the software. For DIPM, the device will send requests to enter Partial or Slumber mode.

#### • Flushing Mechanism for Power Loss Protection

Power Loss Protection is a mechanism to prevent data loss during unexpected power failure. DRAM is a volatile memory and frequently used as temporary cache or buffer between the controller and the NAND flash to improve the SSD performance. However, one major concern of the DRAM is that it is not able to keep data during power failure. Accordingly, the PS3109 applies the *GuaranteedFlush* Technology, which requests the controller to transfer data to the cache. For PS3109 CFast card, SDR performs as a cache, and its sizes is 32MB. Only when the data is fully committed to the NAND flash will the controller send acknowledgement (ACK) to the host. Such implementation can prevent false-positive performance and the risk of power cycling issues.

Additionally, it is critical for a controller to shorten the time the in-flight data stays in the cache. Thus, 's PS3109 applies an algorithm to reduce the amount of data resides in the cache to provide a better performance. This *SmartCacheFlush* technology allows incoming data to only have a "pit stop" in the cache and then move to the NAND flash at once. If the flash is jammed due to particular file sizes (random 4K), the cache will be treated as an "organizer", consolidating incoming data into groups before written into the flash to improve write amplification.

GOODRAM logo is registered trademark of Wilk Elektronik S.A. All other trademarks and logos are the property of their respective owners. All products and specifications are subject to change without notice. Wilk Elektronik S.A. Poland, 43-173 Łaziska Górne, ul. Mikołowska 42 tel.: 0-32/ 736 90 00, fax: 0-32/ 736 90 01 www.wilk.com.pl I www.goodram.com © Wilk Elektronik S.A. 2014

In sum, with this Flush Management, PS3109 proves to provide the reliability required by consumer, industrial, and enterprise-level application.

- Advanced Self-Defense Mechanism
  - Secure Erase

Secure Erase is a standard ATA command and will write all "0xFF" to fully wipe all the data on hard drives and SSDs. When this command is issued, the SSD controller will empty its storage blocks and return to its factory default settings.

# • Write Protect

When a SSD contains too many bad blocks and data are continuously written in, then the SSD might not be used anymore. Thus, Write Protect is a mechanism to prevent data from being written in and protect the accuracy of data that are already stored in the SSD.

- SSD Lifetime Management
  - Terabytes Written (TBW)

TBW (Terabytes Written) is a measurement of SSDs' expected lifespan, which represents the amount of data written to the device. To calculate the TBW of a SSD, the following equation is applied:

# TBW = [(NAND Endurance) x (SSD Capacity) x (WLE)] / WAF

NAND Endurance: NAND endurance refers to the P/E (Program/Erase) cycle of a NAND flash. Typically, the P/E cycle of MLC is 3K.

<u>SSD Capacity</u>: The SSD capacity is the specific capacity in total of a SSD.

- <u>WLE</u>: Wear Leveling Efficiency (WLE) represents the ratio of the average amount of erases on all the blocks to the erases on any block at maximum.
- <u>WAF</u>: Write Amplification Factor (WAF) is a numerical value representing the ratio between the amount of data that a SSD controller needs to write and the amount of data that the host's flash controller writes. A better WAF, which is near 1, guarantees better endurance and lower frequency of data written to flash memory.

#### • Thermal Monitor

Thermal monitors are devices for measuring temperature, and can be found in SSDs in order to issue warnings when SSDs go beyond a certain temperature. The higher temperature the thermal monitor detects, the more power the SSD consumes, causing the SSD to get aging quickly. Hence, the processing speed of a SSD should be under control to prevent temperature from exceeding a certain range. Meanwhile, the SSD can achieve power savings.

#### • Adaptive Performance Tuning Technology

• Throughput

Based on the available space of the disk, PS3109 will regulate the read/write speed and manage the performance of throughput. When there still remains a lot of space, the firmware will continuously perform read/write action. There is still no need to implement garbage collection to allocate and release memory, which will accelerate the read/write processing to improve the performance. Contrarily, when the space is going to be used up, PS3109 will slow down the read/write processing, and implement garbage collection to release memory. Hence, read/write performance will become slower.

Predict Fetch

Normally, when the Host tries to read data from the SSD, the SSD will only perform one read action after receiving one command. However, PS3109 applies *Predict Fetch* to improve the read speed. When the Host issues sequential read commands to the SSD, the SSD will automatically release that the following will also be read commands. Thus, before receiving the next command, flash has already prepared the data. Accordingly, this accelerates the data processing time, and the host does not need to wait so long to receive data.

Wilk Elektronik S.A. Poland, 43-173 Łaziska Górne, ul. Mikołowska 42 tel.: 0-32/ 736 90 00, fax: 0-32/ 736 90 01 www.wilk.com.pl I www.goodram.com © Wilk Elektronik S.A. 2014

# 3. Product Specifications

- Capacity
  - SLC: From 1GB up to 32GB
  - MLC: From 4GB up to 64GB
- Electrical/Physical Interface
  - SATA Interface
    - Compliant with SATA Revision 3.0
    - Compatible with SATA 1.5Gbps, 3Gbps and 6Gbps interface
    - Support power management
    - Support expanded register for SATA protocol 48 bits addressing mode
    - Embedded BIST function for SATA PHY for low cost mass production
  - o Flash IO
    - Support 1.8V and 3.3V voltage level
    - Support 1.8V for ONFI Flash
    - Support 3.3V for conventional Asynchronous Flash
- NAND Flash Interface
  - Toshiba 24nm/19nm SLC, MLC, Toggle1.0 and Toggle2.0
  - Build-in hardware ECC circuit (up to 72bit/1KB)
  - Support all types of SLC/MLC large block: 8KB/page and 16K/page NAND Flash
  - Support ONFI 2.3 interface: 2 channels at maximum
  - o Bus Width: 8/16 bit
  - Contain 1pc or 2pcs of TSOP Flash
- ECC Scheme
  - PS3109 CFast can correct up to 72 bits error in 1K Byte data.

## Performance

Capacity	Flash Structure	Flash Type	Sequential	
			Read	Write
8GB	8GB x 1	Туре В	118.80	45.51
16GB	8GB x 2	Туре В	238.30	86.84
32GB	16GB x 2	Туре В	248.40	154.40
64GB	32GB x 2	Туре В	248.40	154.40

#### NOTES:

- 1. The performance is tested by CrystalDiskMark.
- 2. Samples are made of Toshiba 19nm MLC NAND Flash.
- 3. Performance may vary from flash configuration, SDR configuration, and platform.
- 4. The table above is for your reference only. The criteria for MP (mass production) and for accepting goods shall be discussed based on different flash configuration.
- TBW (Terabytes Written)

Capacity	Flash Structure	TBW
16GB	16GB x 1	39.71
32GB	16GB x 2	79.42
64GB	32GB x 2	158.84

#### **NOTES:**

- 1. Samples are made of Toshiba 19nm Toggle NAND Flash.
- 2. TBW may vary from flash configuration, SDR configuration, and platform.
- Build-in 32-bit micro-controller
- UART function
- GPIO
- Support SMART and TRIM commands

GOODRAM logo is registered trademark of Wilk Elektronik S.A. All other trademarks and logos are the property of their respective owners. All products and specifications are subject to change without notice.

# 4. Environmental Specifications

#### 4.1. Environmental Conditions

- Temperature and Humidity
  - Storage Temperature Range: -40°C to 85°C
- Operation Temperature Range
  - Silver grade: 0°C ~ 70°C
  - Diamond grade: -40°C ~ 85°C
- Humidity:
  - Silver grade : RH 93% under 40°C (in operation)
  - Diamond grade : RH 95% under 55°C (in operation)

	Temperature	Humidity	Test Time
Operation (Silver)	70°C	0% RH	72 hours
Storage (Silver)	85°C	0% RH	72 hours
Operation (Diamond)	85°C	0% RH	72 hours
Storage (Diamond)	85°C	0% RH	168 hours

#### High Temperature Test Condition

**Result:** No any abnormality is detected.

#### Low Temperature Test Condition

	Temperature	Humidity	Test Time
Operation (Silver)	0°C	0% RH	72 hours
Storage (Silver)	-40°C	0% RH	72 hours
Operation (Diamond)	-40°C	0% RH	72 hours
Storage (Diamond)	-40°C	0% RH	168 hours

**Result:** No any abnormality is detected.

High Humidity Test Condition				
Temperature Humidity T			Test Time	
Operation (Silver)	40°C	93% RH	24 hours	
Storage (Silver)	40°C	95% RH	72 hours	
Operation (Diamond)	55°C	95% RH	72 hours	
Storage (Diamond)	55°C	95% RH	96 hours	

**Result:** No any abnormality is detected.

GOODRAM logo is registered trademark of Wilk Elektronik S.A. All other trademarks and logos are the property of their respective owners. All products and specifications are subject to change without notice. Wilk Elektronik S.A. Poland, 43-173 Łaziska Górne, ul. Mikołowska 42 tel.: 0-32/ 736 90 00, fax: 0-32/ 736 90 01 www.wilk.com.pl I www.goodram.com © Wilk Elektronik S.A. 2014

Temperature Cycle Test			
	Temperature	Test Time	Cycle
Operation (Sliver)	0°C	30 min	10 Cycles
,	70°C	30 min	, ,
Storage (Sliver)	-40°C	30 min	10 Cycles
	85°C	30 min	
Operation (Diamond)	-40°C	30 min	20 Cycles
	85°C	30 min	
Storage (Diamond)	-40°C	30 min	50 Cycles
	85°C	30 min	

Result: No any abnormality is detected.

### 4.2. Shock

#### PS3109 CFast Shock Specification

	Acceleration Force	Half Sin Pulse Duration
Non-operational	1500G	0.5ms

**Result:** No any abnormality is detected when power on.

#### 4.3. Vibration

### PS3109 CFast Vibration Specification

	Condition		Vibration Orientation
	Frequency/Displacement	Frequency/Acceleration	
Non-operational	20Hz~80Hz/1.52mm	80Hz~2000Hz/20G	X, Y, Z axis/30 min for each

**Result:** No any abnormality is detected when power on.

#### 4.4. Drop

# PS3109 CFast Drop Specification

	Height of Drop	Number of Drop
Non-operational	110cm free fall	6 face of each unit

**Result:** No any abnormality is detected when power on.

GOODRAM logo is registered trademark of Wilk Elektronik S.A. All other trademarks and logos are the property of their respective owners. All products and specifications are subject to change without notice. Wilk Elektronik S.A. Poland, 43-173 Łaziska Górne, ul. Mikołowska 42 tel.: 0-32/ 736 90 00, fax: 0-32/ 736 90 01 www.wilk.com.pl I www.goodram.com © Wilk Elektronik S.A. 2014

## 4.5. Bending

#### PS3109 CFast Bending Specification

	Force	Action
Non-operational	≥ 20N	Hold 1min/5times

**Result:** No any abnormality is detected when power on.

#### 4.6. Torque

#### PS3109 CFast Torque Specification

	Force	Action	
Non-operational	0.5N-m or ±2.5 deg	Hold 5min/5times	

**Result:** No any abnormality is detected when power on.

#### 4.7. Electrostatic Discharge (ESD)

PS3109 CFast Contact ESD Specification

Device	Capacity	Temperature	Relative Humidity	+/- 4KV	Result
CFast	64GB	24.0°C	49% (RH)	Device functions are affected, but EUT will be back to its normal or operational state automatically.	PASS

#### 4.8. EMI Compliance

- FCC: CISPR22
- CE: EN55022
- BSMI 13438

#### 4.9. MTBF

MTBF, an acronym for Mean Time Between Failures, is a measure of a device's reliability. Its value represents the average time between a repair and the next failure. The measure is typically in units of hours. The higher the MTBF value, the higher the reliability of the device. The predicted result of 's PS3109 CFast is more than 1,000,000 hours.

GOODRAM logo is registered trademark of Wilk Elektronik S.A. All other trademarks and logos are the property of their respective owners. All products and specifications are subject to change without notice. Wilk Elektronik S.A. Poland, 43-173 Łaziska Górne, ul. Mikołowska 42 tel.: 0-32/ 736 90 00, fax: 0-32/ 736 90 01 www.wilk.com.pl I www.goodram.com © Wilk Elektronik S.A. 2014

# 4.10. Certification & Compliance

- RoHS
- SATA III (SATA Rev. 3.0)
- Up to ATA/ATAPI-8 (Including S.M.A.R.T)

# 5. Electrical Specifications

## 5.1. Supply Voltage

Supply Voltage of PS3109 CFast

Parameter	Rating
Operating Voltage	3.3V, +/- 5%
Max. Ripple	100mV, 0~30MHz

#### 5.2. Power Consumption

Power Consumption of PS3109 CFast

Current	Flash Structure	Read	Write	Idle	Partial	Slumber	DEVSLP
16GB	8GB x 2	904	838	276	62	43	4.9
32GB	16GB x 2	1369	1210	292	76	58	4.6
64GB	32GB x 2	1577	1278	301	81	63	4.3

Unit: mW

#### NOTES:

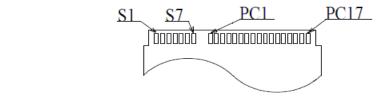
1. Samples are made of Toshiba NAND Flash.

- 2. The operating voltage is 3.3V.
- 3. Power Consumption may vary from flash configuration, SDR configuration, or platform.
- 4. Sequential R/W is measured while testing 4000MB sequential R/W 5 times by CrystalDiskMark.

Wilk Elektronik S.A. Poland, 43-173 Łaziska Górne, ul. Mikołowska 42 tel.: 0-32/ 736 90 00, fax: 0-32/ 736 90 01 www.wilk.com.pl I www.goodram.com © Wilk Elektronik S.A. 2014

# 6. Interface

### 6.1. Pin Assignment and Descriptions



## Signal Pin and Power Pin Assignment and Description of PS3109 CFast

		Pin	_		Meting
Pin #	Segment	Definition	Туре	Description	Sequence
<b>S1</b>	SATA	SGND	Signal GND	Ground for signal integrity	1 <sup>st</sup>
S2	SATA	A+	SATA Differential	Signal Pair A	2 <sup>nd</sup>
<b>S</b> 3	SATA	A-	SATA Differential	Signal Pair A	2 <sup>nd</sup>
<b>S4</b>	SATA	SGND	Signal GND	Ground for signal integrity	1 <sup>st</sup>
S5	SATA	В-	SATA Differential	Signal Pair B	2 <sup>nd</sup>
S6	SATA	B+	SATA Differential	Signal Pair B	2 <sup>nd</sup>
<b>S7</b>	SATA	SGND	Signal GND	Ground for signal integrity	1 <sup>st</sup>
	Кеу				
	Кеу				
PC1	PWR/CTL	CDI	Input	Card Detect In	3 <sup>rd</sup>
PC2	PWR/CTL	PGND	Device GND		1 <sup>st</sup>
PC3	PWR/CTL	DEVSLP	DEVSLP Card Input	DevSleep Power State Enable	2 <sup>nd</sup>
PC4	PWR/CTL			Reserved	2 <sup>nd</sup>
PC5	PWR/CTL			Reserved	2 <sup>nd</sup>
PC6	PWR/CTL			Reserved	2 <sup>nd</sup>
PC7	PWR/CTL	PGND	Device GND		1 <sup>st</sup>
PC8	PWR/CTL	LED1	LED Output	LED Output	2 <sup>nd</sup>
PC9	PWR/CTL	LED2	LED Output	LED Output	2 <sup>nd</sup>
PC10	PWR/CTL			Reserved	2 <sup>nd</sup>

GOODRAM logo is registered trademark of Wilk Elektronik S.A. All other trademarks and logos are the property of their respective owners. All products and specifications are subject to change without notice. Wilk Elektronik S.A. Poland, 43-173 Łaziska Górne, ul. Mikołowska 42 tel.: 0-32/ 736 90 00, fax: 0-32/ 736 90 01 www.wilk.com.pl I www.goodram.com © Wilk Elektronik S.A. 2014

PC11	PWR/CTL			Reserved	2 <sup>nd</sup>
PC12	PWR/CTL	IFDet	GND	Card output, connect to PGND on card	2 <sup>nd</sup>
PC13	PWR/CTL	PWR	3.3V	Device Power (3.3V)	2 <sup>nd</sup>
PC14	PWR/CTL	PWR	3.3V	Device Power (3.3V)	2 <sup>nd</sup>
PC15	PWR/CTL	PGND	Device GND	Device Ground	1 <sup>st</sup>
PC16	PWR/CTL	PGND	Device GND	Device Ground	1 <sup>st</sup>
PC17	PWR/CTL	CDO	Output	Card Detect Out	3 <sup>rd</sup>

# 7. Supported Commands

## 7.1. ATA Command List

	ATA Command List					
Op Code	Description	Op Code	Description			
00h	NOP	97h	IDLE			
06h	Data Set Management	98h	CHECK POWER MODE			
10h-1Fh	Recalibrate	99h	SLEEP			
20h	Read Sectors	BOh	SMART			
21h	Read Sectors without Retry	B1h	DEVICE CONFIGURATION			
24h	Read Sectors EXT	C4h	Read Multiple			
25h	Read DMA EXT	C5h	Write Multiple			
27h	Read Native Max Address EXT	C6h	Set Multiple Mode			
29h	Read Multiple EXT	C8h	Read DMA			
2Fh	Read Log EXT	C9h	Read DMA without Retry			
30h	Write Sectors	CAh	Write DMA			
31h	Write Sectors without Retry	CBh	Write DMA without Retry			
34h	Write Sectors EXT	CEh	Write Multiple FUA EXT			

GOODRAM logo is registered trademark of Wilk Elektronik S.A. All other trademarks and logos are the property of their respective owners. All products and specifications are subject to change without notice. Wilk Elektronik S.A. Poland, 43-173 Łaziska Górne, ul. Mikołowska 42 tel.: 0-32/ 736 90 00, fax: 0-32/ 736 90 01 www.wilk.com.pl I www.goodram.com © Wilk Elektronik S.A. 2014

35h	Write DMA EXT	E0h	Standby Immediate
37h	Set Native Max Address EXT	E1h	Idle Immediate
38h	CFA WRITE SECTORS WITHOUT ERASE	E2h	Standby
39h	Write Multiple EXT	E3h	Idle
3Dh	Write DMA FUA EXT	E4h	Read Buffer
3Fh	Write Long EXT	E5h	Check Power Mode
40h	Read Verify Sectors	E6h	Sleep
41h	Read Verify Sectors without Retry	E7h	Flush Cache
42h	Read Verify Sectors EXT	E8h	Write Buffer
45h	WRITE UNCORRECTABLE EXT	EAh	Flush Cache EXT
60h	Read FPDMA Queued	ECh	Identify Device
61h	Write FPDMA Queued	EFh	Set Features
70h-7Fh	Seek	F1h	Security Set Password
90h	Execute Device Diagnostic	F2h	Security Unlock
91h	Initialize Device Parameters	F3h	Security Erase Prepare
92h	Download Microcode	F4h	Security Erase Unit
93h	DOWNLOAD MICROCODE DMA	F5h	Security Freeze Lock
94h	STANDBY IMMEDIATE	F6h	Security Disable Password
95h	IDLE IMMEDIATE	F8h	Read Native Max Address
96h	STANDBY	F9h	Set Max Address

Wilk Elektronik S.A. Poland, 43-173 Łaziska Górne, ul. Mikołowska 42 tel.: 0-32/ 736 90 00, fax: 0-32/ 736 90 01 www.wilk.com.pl I www.goodram.com © Wilk Elektronik S.A. 2014

# 7.2. Identify Device Data

The following table details the sector data returned by the IDENTIFY DEVICE command.

	F: Fixed		
Word	V: Variable X: Both	Default Value	Description
0	F	0040h	General configuration bit-significant information
1	Х	*1	Obsolete – Number of logical cylinders
2	V	C837h	Specific configuration
3	X	0010h	Obsolete – Number of logical heads (16)
4-5	Х	00000000h	Retired
6	X	003Fh	Obsolete – Number of logical sectors per logical track (63)
7-8	V	00000000h	Reserved for assignment by the Compact Flash Association
9	Х	0000h	Retired
10-19	F	Varies	Serial number (20 ASCII characters)
20-21	Х	0000h	Retired
22	Х	0000h	Obsolete
23-26	F	Varies	Firmware revision (8 ASCII characters)
27-46	F	Varies	Model number (xxxxxxx)
47	F	8010h	7:0- Maximum number of sectors transferred per interrupt on MULTIPLE commands
48	F	4000h	Trusted Computing feature set options(not support)
49	F	2F00h	Capabilities
50	F	4000h	Capabilities
51-52	Х	000000000h	Obsolete
53	F	0007h	Words 88 and 70:64 valid

List of [	Device	Identification
-----------	--------	----------------

GOODRAM logo is registered trademark of Wilk Elektronik S.A. All other trademarks and logos are the property of their respective owners. All products and specifications are subject to change without notice. Wilk Elektronik S.A. Poland, 43-173 Łaziska Górne, ul. Mikołowska 42 tel.: 0-32/ 736 90 00, fax: 0-32/ 736 90 01 www.wilk.com.pl I www.goodram.com © Wilk Elektronik S.A. 2014

54	Х	*1	Obsolete – Number of logical cylinders	
55	Х	0010h	Obsolete – Number of logical heads (16)	
56	Х	003Fh	Obsolete – Number of logical sectors per track (63)	
57-58	Х	*2	Obsolete – Current capacity in sectors	
59	F	0110h	Number of sectors transferred per interrupt on MULTIPLE commands	
60-61	F	*3	Maximum number of sector ( 28bit LBA mode)	
62	Х	0000h	Obsolete	
63	F	0407h	Multi-word DMA modes supported/selected	
L				
64	F	0003h	PIO modes supported	
65	F	0078h	Minimum Multiword DMA transfer cycle time per word	
66	F	0078h	Manufacturer's recommended Multiword DMA transfer cycle time	
67	F	0078h	Minimum PIO transfer cycle time without flow control	
68	F	0078h	Minimum PIO transfer cycle time with IORDY flow control	
69	F	0100h	Additional Supported (support download microcode DMA)	
70	F	0000h	Reserved	
71-74	F	00000000000000000000000000000000000000	Reserved for the IDENTIFY PACKET DEVICE command	
75	F	001Fh	Queue depth	
76	F	670eh	Serial SATA capabilities	
77	F	0084h	Serial ATA Additional Capabilities	
78	F	014Ch	Serial ATA features supported	
79	V	0040h	Serial ATA features enabled	
80	F	07F8h	Major Version Number	
81	F	0000h	Minor Version Number	

Wilk Elektronik S.A. Poland, 43-173 Łaziska Górne, ul. Mikołowska 42 tel.: 0-32/ 736 90 00, fax: 0-32/ 736 90 01 www.wilk.com.pl I www.goodram.com © Wilk Elektronik S.A. 2014

82	F	346bh	Command set supported	
83	F	7d09h	Command set supported	
84	F	6063h	Command set/feature supported extension	
85	V	3469h	Command set/feature enabled	
86	V	bc01h	Command set/feature enabled	
87	V	6063h	Command set/feature default	
88	V	003Fh	Ultra DMA Modes	
89	F	0001h	Time required for security erase unit completion	
90	F	001Eh	Time required for Enhanced security erase completion	
91	V	0000h	Current advanced power management value	
92	V	FFFEh	Master Password Revision Code	
93	F	0000h	Hardware reset result. The contents of the bits (12:0) of this word can be changed only during the execution of hardware reset.	
94	V	0000h	Vendor's recommended and actual acoustic management value	
95	F	0000h	Stream Minimum Request Size	
96	V	0000h	Streaming Transfer Time – DMA	
97	V	0000h	Streaming Access Latency – DMA and PIO	
98-99	F	0000h	Streaming Performance Granularity	
100-103	V	*4	Maximum user LBA for 48 bit Address feature set	
104	V	0000h	Streaming Transfer Time – PIO	
105	F	0008h	Maximum number of 512-byte blocks per DATA SET MANAGEMENT command	
106	F	4000h	Physical sector size/Logical sector size	
107	F	0000h	Inter-seek delay for ISO-7779 acoustic testing in microseconds	
108-111	F	000000000000000000000000000000000000000	Unique ID	

Wilk Elektronik S.A. Poland, 43-173 Łaziska Górne, ul. Mikołowska 42 tel.: 0-32/ 736 90 00, fax: 0-32/ 736 90 01 www.wilk.com.pl I www.goodram.com © Wilk Elektronik S.A. 2014

		Oh		
112-115	F	00000000000000000000000000000000000000	Reserved	
116	V	0000h	Reserved	
117-118	F	00000000h	Words per logical Sector	
119	F	4014h	Supported settings	
120	F	4014h	Command set/Feature Enabled/Supported	
121-126	F	Oh	Reserved	
127	F	Oh	Removable Media Status Notification feature set support	
128	V	0021h	Security status	
129-140	Х	Oh	Vendor specific	
141	Х	0001h	Vendor specific	
142-159	Х	Oh	Vendor specific	
160	F	Oh	Compact Flash Association (CFA) power mode 1	
161-167	Х	Oh	Reserved for assignment by the CFA	
168	F	3h 2.5 inch	Device Nominal Form Factor	
		4h 1.8 inch		
		5h Less than 1.8 inch		
169	F	0001h	DATA SET MANAGEMENT command is supported	
170-173	F	Oh	Additional Product Identifier	
174-175		Oh	Reserve	
176-205	V	Oh	Current media serial number	
206	F	Oh	SCT Command Transport	
207-208	F	Oh	Reserved	
209	F	4000h	Alignment of logical blocks within a physical block	
210-211	V	0000h	Write-Read-Verify Sector Count Mode 3 (not support)	

Wilk Elektronik S.A. Poland, 43-173 Łaziska Górne, ul. Mikołowska 42 tel.: 0-32/ 736 90 00, fax: 0-32/ 736 90 01 www.wilk.com.pl I www.goodram.com © Wilk Elektronik S.A. 2014

212-213	F	0000h	Write-Read-Verify Sector Count Mode 2 (not support		
214-216		0000h	NV Cache relate (not support)		
217	F	0001h	Non-rotating media device		
218	F	Oh	Reserved		
219	F	Oh	NV Cache relate (not support)		
220	V	Oh	Write read verify feature set current mode		
221		Oh	Reserved		
222	F	107Fh	Transport major version number		
223	F	Oh	Transport minor version number		
224-229		Oh	reserved		
230-233		Oh	Extend number of user addressable sectors		
234		0001h	Minimum number of 512-byte data blocks per		
			DOWNLOAD MICROCODE command for mode 03h		
235		0080h	Maximum number of 512-byte data blocks per		
			DOWNLOAD MICROCODE command for mode 03h		
236-254	F	Oh	Reserved		
255	Х	XXA5h	Integrity word (Checksum and Signature)		
		XX is variable			

## List of Device Identification for Each Capacity

Capacity	*1	*2	*3	*4
(GB)	(Word 1/Word 54)	(Word 57 – 58)	(Word 60 – 61)	(Word 100 – 103)
4	1E5Dh	778E30h	778E30h	778E30h
8	3CA5h	EEC9B0h	EEC9B0h	EEC9B0h
16	3FFFh	FBFC10h	1DD40B0h	1DD40B0h
24	3FFFh	FBFC10h	2CBB7B0h	2CBB7B0h
32	3FFFh	FBFC10h	3BA2EB0h	3BA2EB0h

GOODRAM logo is registered trademark of Wilk Elektronik S.A. All other trademarks and logos are the property of their respective owners. All products and specifications are subject to change without notice.

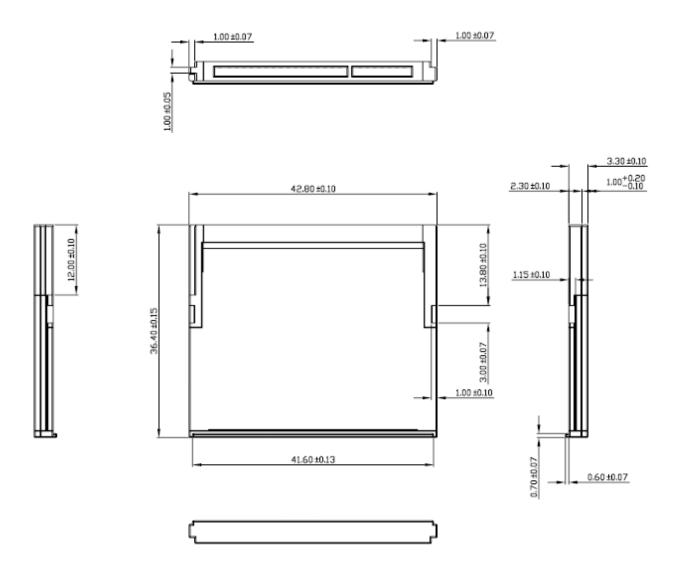
Γ

Wilk Elektronik S.A. Poland, 43-173 Łaziska Górne, ul. Mikołowska 42 tel.: 0-32/ 736 90 00, fax: 0-32/ 736 90 01 www.wilk.com.pl I www.goodram.com © Wilk Elektronik S.A. 2014

64	3FFFh	FBFC10h	7740AB0h	7740AB0h
128	3FFFh	FBFC10h	EE7C2B0h	EE7C2B0h
256	3FFFh	FBFC10h	FFFFFFh	1DCF32B0h

# 8. Physical Dimension

CFastTM Type I: 36.4mm (L) x 42.8mm (W) x 3.3mm (H)



GOODRAM logo is registered trademark of Wilk Elektronik S.A. All other trademarks and logos are the property of their respective owners. All products and specifications are subject to change without notice. Wilk Elektronik S.A. Poland, 43-173 Łaziska Górne, ul. Mikołowska 42 tel.: 0-32/ 736 90 00, fax: 0-32/ 736 90 01 www.wilk.com.pl I www.goodram.com © Wilk Elektronik S.A. 2014

#### Warning

• Do not bend, crush, drop, or place heavy objects on top of the Product. Do not use tweezers, pliers, or similar items that could damage the Product. Take particular care when inserting or removing the Product. Stop using the Product when the Product does not work properly. Failure to follow these instructions could result in fire, damage to the Product and/or other property, and/or personal injury including burns and electric shock.

• Keep out of reach of small children. Accidental swallowing may cause suffocation or injury. Contact a doctor immediately if you suspect a child has swallowed the Product.

• Do not directly touch the interface pins, put them in contact with metal, strike them with hard objects, or cause them to short. Do not expose to static electricity.

• Do not disassemble or modify the Product. This may cause electric shock, damage to the Product, or fire.

#### Notes on usage

• The Product contains nonvolatile semiconductor memory. Do not use the Product in accordance with a method of usage other than that written in the manual. This may cause the destruction or loss of data.

• To protect against accidental data loss, you should back up your data frequently on more than one type of storage media. \*\*\*\* Corporation assumes no liability for destruction or loss of data recorded on the Card for any reason.

• When used over a long period of time or repeatedly, the reading, writing and deleting capabilities of the Product will eventually fail, and the performance speed of the Product may decrease below the original speed specific to the Product's applicable class.

• If the Product is to be transferred or destroyed, note that the data it contained may still be recoverable unless it is permanently deleted by third-party deletion software or similar means beforehand.

#### Product applications and design.

Product is intended for use in general electronics applications (e.g., computers, personal equipment, office equipment, measuring equipment, industrial robots and home electronics appliances) or for specific applications as expressly stated in this document. Product is neither intended nor warranted for use in equipment or systems that require extraordinarily high levels of quality and/or reliability and/or a malfunction or failure of which may cause loss of human life, bodily injury, serious property damage or serious public impact ("Unintended Use"). Unintended Use includes, without limitation, equipment used in nuclear facilities, equipment used in the aerospace industry, medical equipment, equipment used for automobiles, trains, ships and other transportation, traffic signaling equipment, equipment used to control combustions or explosions, safety devices, elevators and escalators, devices related to electric power, and equipment used in finance-related fields. Do not use Product for Unintended Use unless specifically permitted in this document.

No parts of this document may be reproduced, stored in a retrieval system, or transmitted, in any form or by any means, mechanical ,electric, photocopying, recording or otherwise, without permission of Wilk Elektronik S.A. Wilk Elektronik S.A does not make any warranty ,express or implied, with respect to this document, including as to licensing, Non-infringement, merchantability or fitness for a particular purpose.

GOODRAM logo is registered trademark of Wilk Elektronik S.A. All other trademarks and logos are the property of their respective owners. All products and specifications are subject to change without notice. Wilk Elektronik S.A. Poland, 43-173 Łaziska Górne, ul. Mikołowska 42 tel.: 0-32/ 736 90 00, fax: 0-32/ 736 90 01 www.wilk.com.pl I www.goodram.com © Wilk Elektronik S.A. 2014